



SBR02M30LP

#### 0.2A SBR SUPER BARRIER RECTIFIER

#### **Features**

- Ultra-Low Leakage Current
- **Excellent High Temperature Stability**
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +175°C Operating Junction Temperature
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability



Top View

### **Mechanical Data**

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)



**Bottom View** 

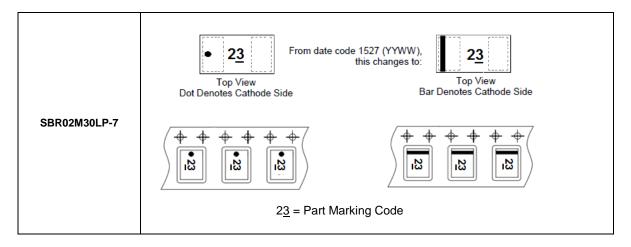
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
SBR02M30LP-7	X1-DFN1006-2	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**





# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	30	<b>V</b>
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	V
Average Rectified Output Current (See Figure 1)	Ιο	0.2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	5.0	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 5) Thermal Resistance Junction to Ambient (Note 6)	$R_{ heta JS} \ R_{ heta JA}$	18 263	°C/W
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +175	°C

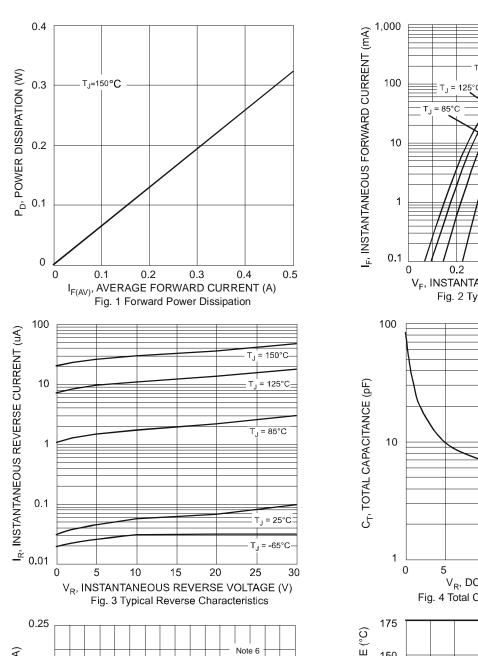
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

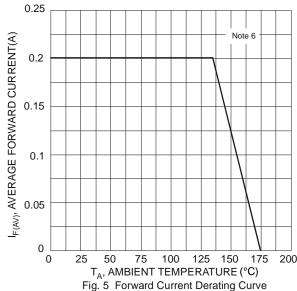
Characteristic	Symbol	Min	Тур.	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	30	-	=	V	$I_R = 400\mu A$
Forward Voltage Drop	V <sub>F</sub>	-	0.50 0.42 0.57 0.51	0.54 0.45 0.61 0.54	V	$I_F = 0.1A$ , $T_J = +25^{\circ}C$ $I_F = 0.1A$ , $T_J = +150^{\circ}C$ $I_F = 0.2A$ , $T_J = +25^{\circ}C$ $I_F = 0.2A$ , $T_J = +150^{\circ}C$
Leakage Current (Note 7)	I <sub>R</sub>	-	0.1 46	0.5 150	μΑ	$V_R = 30V, T_J = +25$ °C $V_R = 30V, T_J = +150$ °C

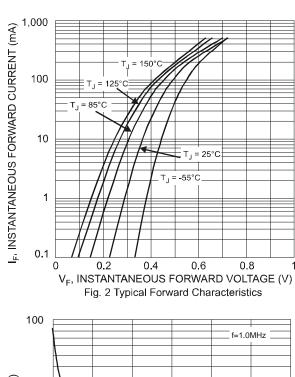
Notes:

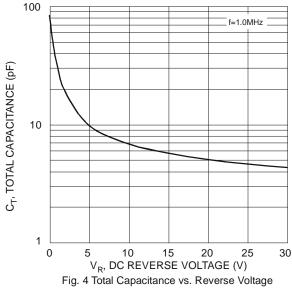
- 5. Theoretical  $R_{\theta JS}$  calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 6. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

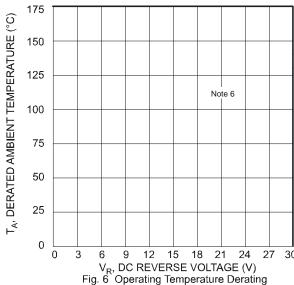










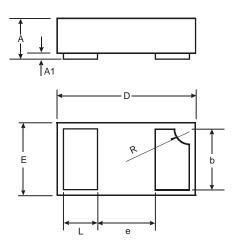




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-2

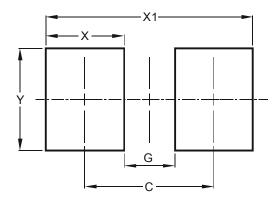


X1-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-2



Dimensions	Value (in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Υ	0.70



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